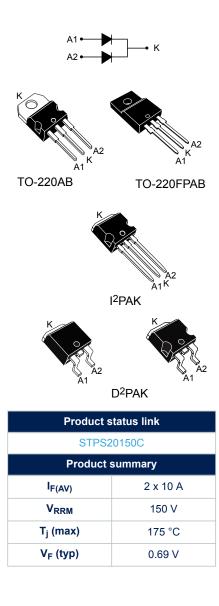


# STPS20150C

Datasheet

# High voltage power Schottky rectifier



### **Features**

- High junction temperature capability
- Good trade off between leakage current and forward voltage drop
- Low leakage current
- Avalanche capability specified
- Insulated package: TO-220FPAB
  - Insulating voltage = 2000 V<sub>RMS</sub> sine
- ECOPACK<sup>®</sup>2 compliant component for D<sup>2</sup>PAK on demand

### **Description**

Dual center tap Schottky rectifier designed for high frequency switch mode power supplies.

# 1 Characteristics

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#### Table 1. Absolute ratings (limiting values, per diode, at 25 °C, unless otherwise specified)

Symbol	Parameter					Unit
V <sub>RRM</sub>	Repetitive peak reverse voltage		150	V		
I <sub>F(RMS)</sub>	Forward rms current					Α
	Average forward current $\delta$ = 0.5, square wave	TO-220AB, D <sup>2</sup> PAK, I <sup>2</sup> PAK	T <sub>C</sub> = 155 °C	Per diode	10	
		TO-220FPAB	T <sub>C</sub> = 135 °C	Per diode	10	A
		All types Per device			20	1
I <sub>FSM</sub>	Surge non repetitive forward current	tp = 10 ms sinusoidal	tp = 10 ms sinusoidal			Α
P <sub>ARM</sub>	Repetitive peak avalanche power	valanche power $tp = 10 \ \mu s, T_j = 125 \ ^{\circ}C$			480	W
T <sub>stg</sub>	Storage temperature range				-65 to + 175	°C
Тј	Maximum operating junction temperature (1)			+ 175	°C	

1.  $(dP_{tot}/dT_j) < (1/R_{th(j-a)})$  condition to avoid thermal runaway for a diode on its own heatsink.

#### Table 2. Thermal parameter

Symbol		Parameter			Unit
		TO-220AB, D <sup>2</sup> PAK, I <sup>2</sup> PAK	Per diode	2.2	°C/W
Du a x	Junction to case	TO-220FPAB	Fei diode	4.5	
R <sub>th(j-c)</sub>	Junction to case	TO-220AB, D <sup>2</sup> PAK, I <sup>2</sup> PAK	Total	1.3	
		TO-220FPAB	TOTAL	3.5	
P	Coupling	TO-220AB, D <sup>2</sup> PAK, I <sup>2</sup> PAK		0.3	°C/W
R <sub>th(c)</sub>	Coupling	TO-220FPAB		2.5	

When the diodes 1 and 2 are used simultaneously :

 $\Delta$ Tj(diode 1) = P(diode1) x R<sub>th(j-c)</sub>(Per diode) + P(diode 2) x R<sub>th(c)</sub>

Table 3.	<b>Static electrical</b>	characteristics	(per diode)
			(100.0.000)

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I <sub>R</sub> <sup>(1)</sup> Reverse leakage cu		T <sub>j</sub> = 25 °C	\/_ = \/	-		5.0	μA
	Reverse leakage current	T <sub>j</sub> = 125 °C	V <sub>R</sub> = V <sub>RRM</sub>	-		5.0	mA
VF <sup>(2)</sup> F			I <sub>F</sub> = 10 A	-		0.92	
	Forward voltage drop	T <sub>i</sub> = 25 °C	1F - 10 A	-	0.69	0.75	V
	Forward voltage drop	1,-25 0	I <sub>F</sub> = 20A	-		1.0	V
			IF - 207	-	0.79	0.86	

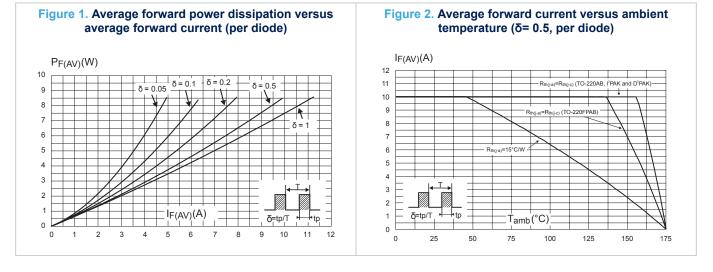
1. Pulse test:  $t_p = 5 ms$ ,  $\delta < 2\%$ 

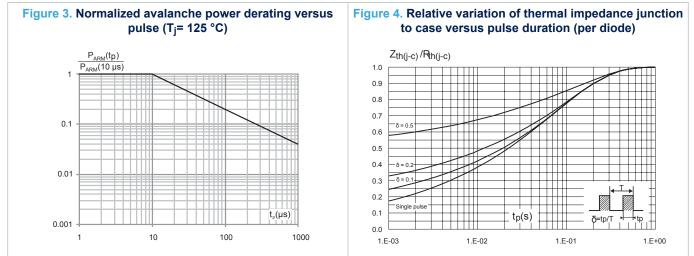
2. Pulse test:  $t_p = 380 \ \mu s, \ \delta < 2\%$ 

To evaluate the conduction losses use the following equation: P = 0.64 x  $I_{F(AV)}$  + 0.011  $I_{F}^{2}(RMS)$ 



### 1.1 Characteristics (curves)





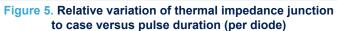
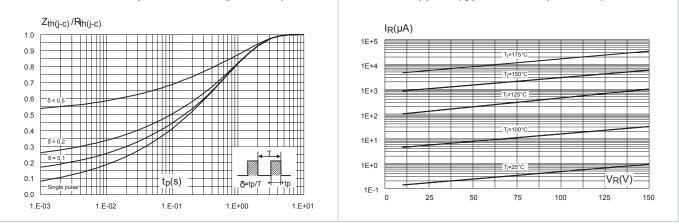
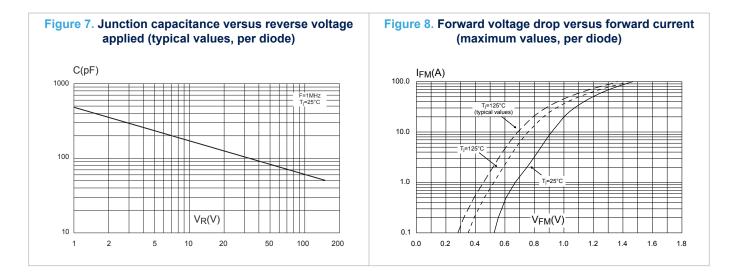
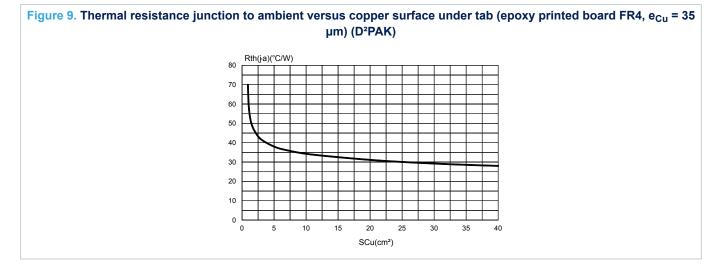


Figure 6. Reverse leakage current versus reverse voltage applied (typical values, per diode)









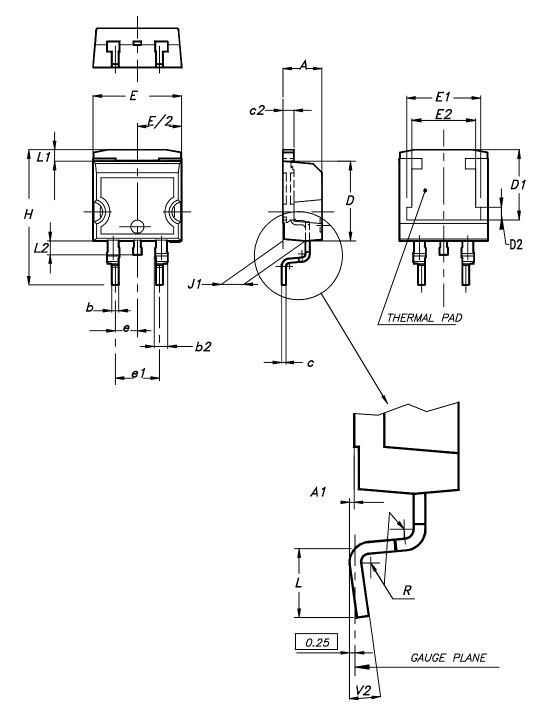
# 2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: www.st.com. ECOPACK<sup>®</sup> is an ST trademark.

# 2.1 D<sup>2</sup>PAK package information

- Cooling method: by conduction (C)
- Epoxy meets UL 94,V0

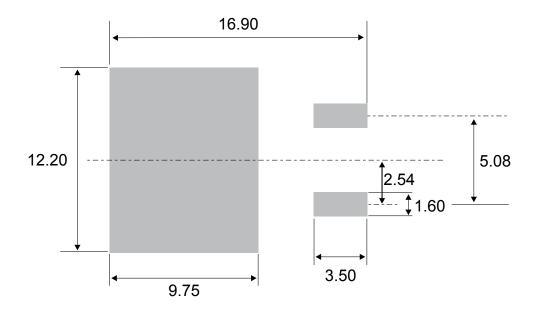




	Dimensions				
Ref.	Millimet	ers	Incl	nes	
	Min.	Max.	Min.	Max.	
А	4.36	4.60	0.172	0.181	
A1	0.00	0.25	0.000	0.010	
b	0.70	0.93	0.028	0.037	
b2	1.14	1.70	0.045	0.067	
С	0.38	0.69	0.015	0.027	
c2	1.19	1.36	0.047	0.053	
D	8.60	9.35	0.339	0.368	
D1	6.90	8.00	0.272	0.311	
D2	1.10	1.50	0.043	0.060	
E	10.00	10.55	0.394	0.415	
E1	8.10	8.90	0.319	0.346	
E2	6.85	7.25	0.266	0.282	
е	2.54 ty	p.	0.100		
e1	4.88	5.28	0.190	0.205	
Н	15.00	15.85	0.591	0.624	
J1	2.49	2.90	0.097	0.112	
L	1.90	2.79	0.075	0.110	
L1	1.27	1.65	0.049	0.065	
L2	1.30	1.78	0.050	0.070	
R	0.4 typ	).	0.0	15	
V2	0°	8°	0°	8°	

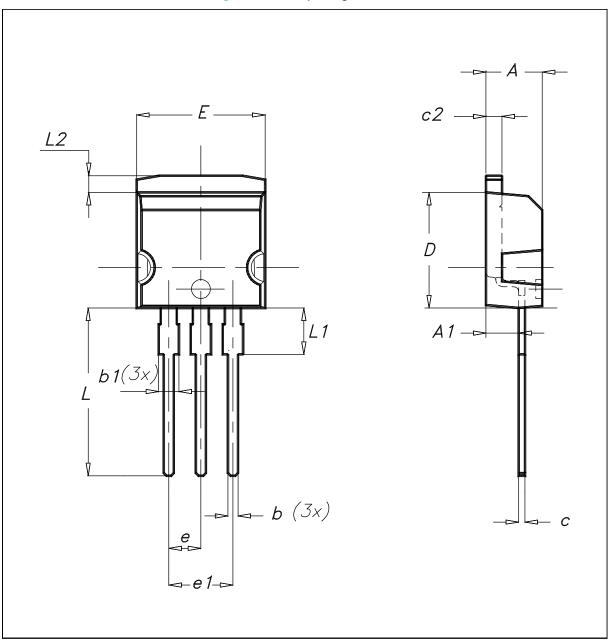
### Table 4. D<sup>2</sup>PAK package mechanical data





# 2.2 I<sup>2</sup>PAK package information

- Cooling method: by conduction (C)
- Epoxy meets UL 94,V0





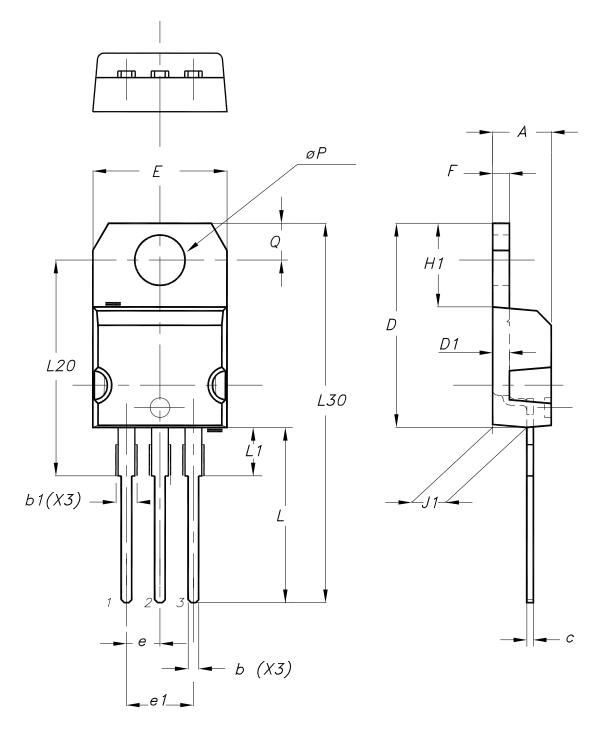
		Dimensions				
Ref.	Millimeters		Inc	hes		
	Min.	Max.	Min.	Max.		
А	4.40	4.60	0.173	0.181		
A1	2.40	2.72	0.094	0.107		
b	0.61	0.88	0.024	0.035		
b1	1.14	1.70	0.044	0.067		
С	0.49	0.70	0.019	0.028		
c2	1.23	1.32	0.048	0.052		
D	8.95	9.35	0.352	0.368		
е	2.40	2.70	0.094	0.106		
e1	4.95	5.15	0.195	0.203		
E	10.00	10.40	0.394	0.409		
L	13.00	14.00	0.512	0.551		
L1	3.50	3.93	0.138	0.155		
L2	1.27	1.40	0.050	0.055		

### Table 5. I<sup>2</sup>PAK package mechanical data

### 2.3 TO-220AB package information

- Cooling method: by conduction (C)
- Epoxy meets UL 94,V0
- Recommended torque value: 0.55 N·m
- Maximum torque value: 0.7 N·m

### Figure 13. TO-220AB package outline



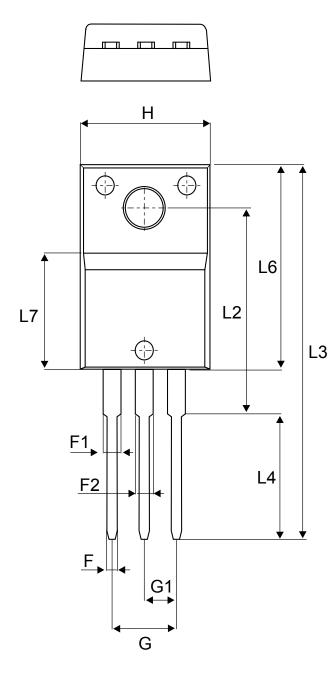
		Dime	nsions	
Ref.	Millime	ters	Inch	es
	Min.	Max.	Min.	Max.
A	4.40	4.60	0.173	0.181
b	0.61	0.88	0.240	0.035
b1	1.14	1.55	0.045	0.061
С	0.48	0.70	0.019	0.028
D	15.25	15.75	0.600	0.620
D1	1.27 t	yp.	0.050	typ.
E	10.00	10.40	0.394	0.409
е	2.40	2.70	0.094	0.106
e1	4.95	5.15	0.195	0.203
F	1.23	1.32	0.048	0.052
H1	6.20	6.60	0.244	0.260
J1	2.40	2.72	0.094	0.107
L	13.00	14.00	0.512	0.551
L1	3.50	3.93	0.138	0.155
L20	16.40 typ.		0.646	typ.
L30	28.90 typ.		1.138 typ.	
θΡ	3.75	3.85	0.148	0.152
Q	2.65	2.95	0.104	0.116

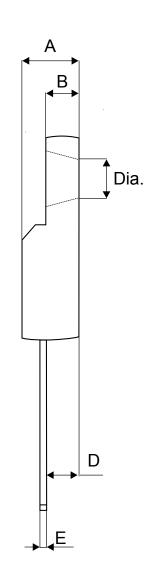
### Table 6. TO-220AB package mechanical data

# 2.4 TO-220FPAB package information

- Cooling method: by conduction (C)
- Epoxy meets UL 94,V0
- Recommended torque value: 0.55 N·m
- Maximum torque value: 0.7 N·m

### Figure 14. TO-220FPAB package outline





			Dimensions	
Ref.	Millim	neters	Inches (for re	ference only)
	Min.	Max.	Min.	Max.
А	4.40	4.60	0.1739	0.1818
В	2.5	2.7	0.0988	0.1067
D	2.50	2.75	0.0988	0.1087
E	0.45	0.70	0.0178	0.0277
F	0.75	1.0	0.0296	0.0395
F1	1.15	1.70	0.0455	0.0672
F2	1.15	1.70	0.0455	0.0672
G	4.95	5.20	0.1957	0.2055
G1	2.40	2.70	0.0949	0.1067
Н	10.00	10.40	0.3953	0.4111
L2	16.00	0 typ.	0.6324	4 typ.
L3	28.60	30.60	1.1304	1.2095
L4	9.80	10.6	0.3874	0.4190
L5	2.90	3.60	0.1146	0.1423
L6	15.90	16.40	0.6285	0.6482
L7	9.00	9.30	0.3557	0.3676
Dia	3.0	3.20	0.1186	0.1265

### Table 7. TO-220FPAB package mechanical data

# **3** Ordering information

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Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS20150CT	STPS20150CT	TO-220AB	1.95 g	50	Tube
STPS20150CFP	STPS20150CFP	TO-220FPAB	1.9 g	50	Tube
STPS20150CR	STPS20150CR	I <sup>2</sup> PAK	1.5 g	50	Tube
STPS20150CG-TR	STPS20150CG	D <sup>2</sup> PAK	1.38 g	1000	Tape and reel
STPS20150CG	STPS20150CG	D <sup>2</sup> PAK	1.38 g	50	Tube

### Table 8. Ordering information

# **Revision history**

Date	Revision	Changes
Jul-2003	6D	Last update
11-May-2006	7	Reformatted to current standard. Added ECOPACK statement.
		Changed nF to pF in Figure 10.
07-Mar-2007	8	Reworked footnote to Table 1. Corrected typing error in Table 3.
28-Jan-2011	9	Updated weight in Table 9. Added warning paragraph above Table 6.
24-Aug-2015	10	Updated features, Table 1: "Device summary" and packages silhouette in cover page.
		Updated Section 1: "Characteristics" and Section 1.1: "Characteristics(curves)".
		Updated Section 2.2: "D <sup>2</sup> PAK package information".
08-Fev-2018	11	Updated I <sup>2</sup> PAK package information.
10-Apr-2018	12	Updated Table 5. I <sup>2</sup> PAK package mechanical data.

### Table 9. Document revision history



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